

**AMENDMENTS TO THE SPECIFICATION**

**Please amend the paragraph beginning at page 1, line 14 as follows:**

~~{Background Art}~~

Background of the Invention

**Please amend the paragraph beginning at page 2, line 24 as follows:**

[Patent Document 1] Japanese Patent Application Laid-open No. Hei 6-216242

~~{Disclosure of the Invention}~~

~~{Problem to be Solved by the Invention}~~

**Please amend the paragraph beginning at page 4, line 4 as follows:**

~~{Objects of the Invention}~~

**Please amend the paragraph beginning at page 4, line 19 as follows:**

~~{Means for Solving the Problem}~~

**Please amend the paragraph beginning at page 7, line 13 as follows:**

~~{Advantageous Effect of the Invention}~~

**At page 8, line 14, please insert the following:**

Brief Description of the Drawings

Fig. 1 is an elevation schematically showing the mounting apparatus in accordance with the present embodiment.

Fig. 2 is a perspective view schematically showing an essential part in Fig. 1.

Fig. 3 is a sectional view schematically showing a table.

Fig. 4 is a perspective view identical to Fig. 2 schematically showing a state after a dicing tape is stuck.

Fig. 5 is a perspective view schematically showing an essential part of a modification.

Fig. 6 is a perspective view schematically showing an essential part of further another modification.

**Please amend the paragraph beginning at page 8, line 15 as follows:**

**[Best Mode for Carrying Out the Invention]**

**Detailed Description of the Invention**

**Please amend the paragraph beginning at page 18, line 26 as follows:**

**[Brief Description of the Drawing]**

**[0030]**

**[Fig. 1]**

**Fig. 1 is an elevation schematically showing the mounting apparatus in accordance with the present embodiment.**

**[Fig. 2]**

~~Fig. 2 is a perspective view schematically showing an essential part in Fig. 1.~~

~~[Fig. 3]~~

~~Fig. 3 is a sectional view schematically showing a table.~~

~~[Fig. 4]~~

~~Fig. 4 is a perspective view identical to Fig. 2 schematically showing a state after a dicing  
tape is stuck.~~

~~[Fig. 5]~~

~~Fig. 5 is a perspective view schematically showing an essential part of a modification.~~

~~[Fig. 6]~~

~~Fig. 6 is a perspective view schematically showing an essential part of further another  
modification.~~

[Explanation of reference numerals]

[0031]

10—mounting apparatus

11—table

12—support roller (supporting means)

13—pre-cut device

21—dancer roller

34—sticking means

35—die roller

A—strip material

Application No. 10/574,847  
Art Unit: 1745

Amendment  
Attorney Docket No. 062289

L—cut

T—dieing tape

W—semiconductor wafer

FL—film

RF—ring frame

S1, S2—sensor